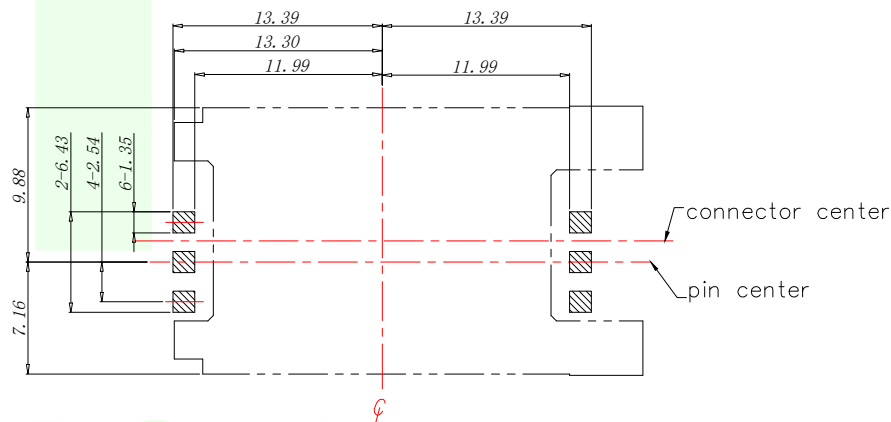
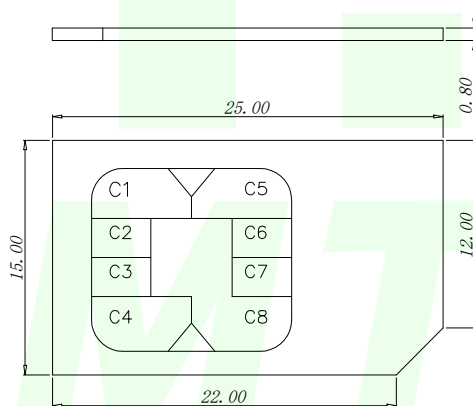
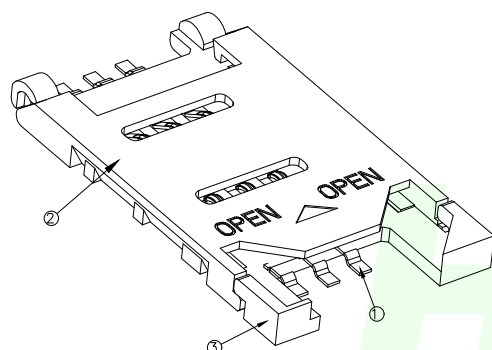
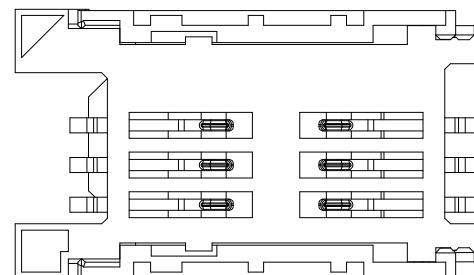
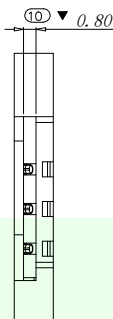
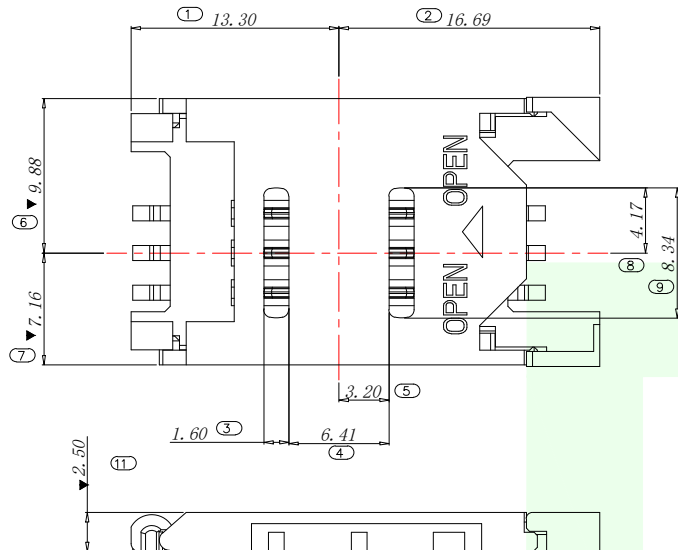


RoHs

VER	MARK	PR. BY	DESCRIPTION	DATE



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE: ± 0.05)

RECOMMENDED METAL MASK T=0.12mm

-  SMT SOLDER AREA
 NO PATTERN AND VIA HOLE IN HTIS AREA

NOTES:

1)MATERIAL:

HOUSING: THERMOPLASTIC,UL 94V-0, COLOR:BLACK

CONTACT: COPPER ALLOY

2)FINISH

CONTACT: GOLD FLASH

SOLDER AREA: TIN 100u" Min

3)Solder-ability

IR reflow: 250°C,5sec.Max

Manual soldering: 350°C ,3sec.max

1	Contact	COPPER ALLOY	Gold FLASH	6	
2	Cover	THERMOPLASTIC,UL 94V-0, COLOR:BLACK		1	
3	Housing	THERMOPLASTIC,UL 94V-0, COLOR:BLACK		1	
ITEM	NAME	MATERIAl	FINISH	Q'ty	REMARK

GENERAL TOLERANCES
UNLESS SPECIFIED

X.X ± 0.30 X.° $\pm 5^\circ$

.XX ± 0.20 X.X° $\pm 1^\circ$

.XXX ± 0.10 X.XX° $\pm 0.5^\circ$

MANUFACTURE DWG

GENERAL TOLERANCES UNLESS SPECIFIED		 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd	
PART NO. SIM10120-6P211-H25		TITLE: 2.5H 6PIN HINGE MINI SIM CARD CONNECTOR	
DESIGN: James	CUSTOMER	SIZE A4	UNITS MM
CHED: Talen		SCALE N: A	SHEET 1/1
APPD: Sophia			